



**GP**  
**ELECTRONICS**

**GP2303S**

**30V P-Channel MOSFET**

### Product Summary

$V_{(BR)DSS}$	$R_{DS(on)}TYP$	$I_D$
-30V	99m $\Omega$ @-10V	-1.9A
	120m $\Omega$ @-4.5V	
	184m $\Omega$ @-2.5V	

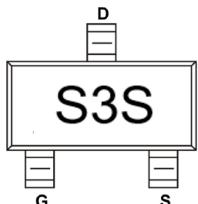
### Feature

- Trench Technology Power MOSFET
- Low  $R_{DS(ON)}$
- Low Gate Charge

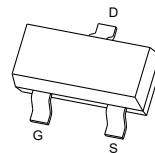
### Application

- Load Switch
- DC/DC Converter

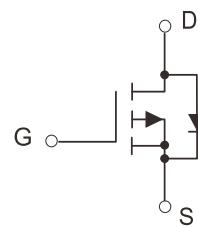
### MARKING



**SOT-23**



**Schematic diagram**



### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain - Source Voltage	$V_{DS}$	-30	V
Gate - Source Voltage	$V_{GS}$	$\pm 12$	V
Continuous Drain Current <sup>1,4</sup>	$I_D$	-1.9	A
		-1.2	
Pulsed Drain Current <sup>2</sup>	$I_{DM}$	-7.6	A
Power Dissipation <sup>4,5</sup>	$P_D$	0.63	W
Thermal Resistance from Junction to Ambient <sup>5</sup>	$R_{\theta JA}$	200	°C/W
Junction Temperature	$T_J$	150	°C
Storage Temperature	$T_{STG}$	-55~+150	°C

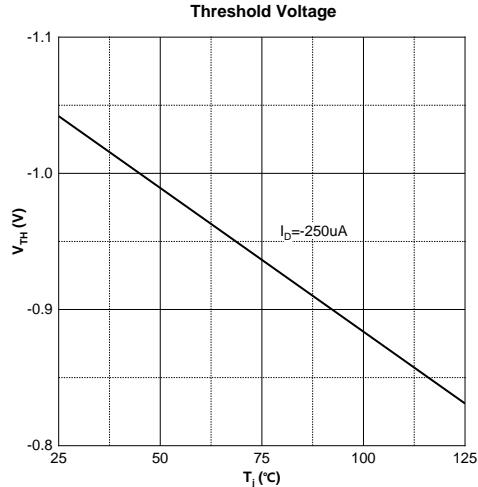
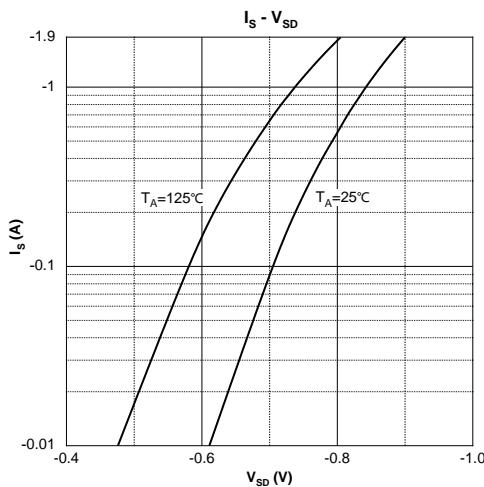
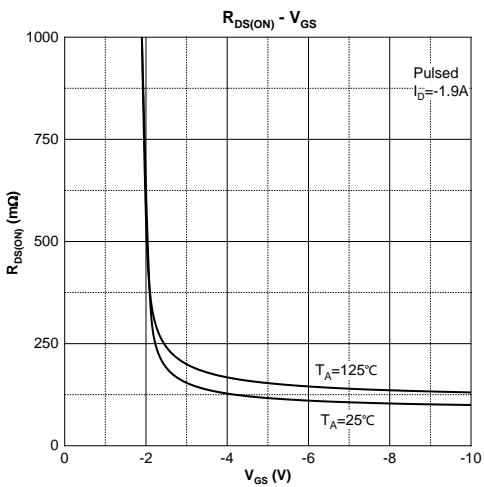
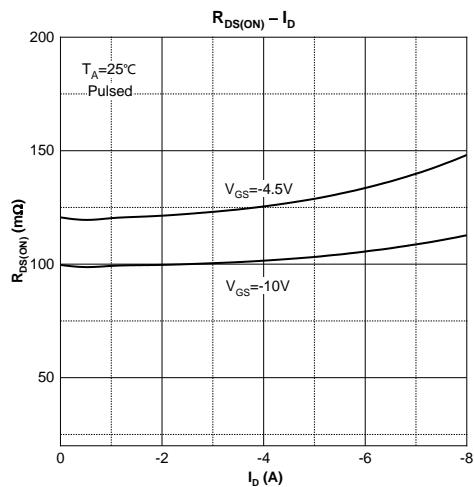
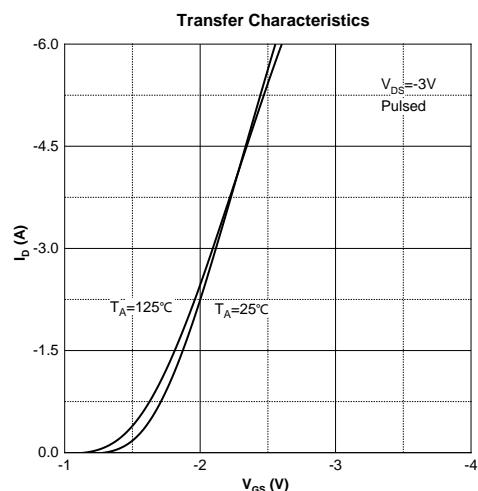
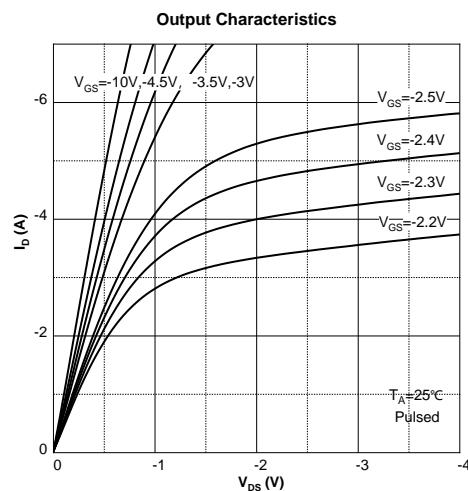
**MOSFET ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$  unless otherwise noted)**

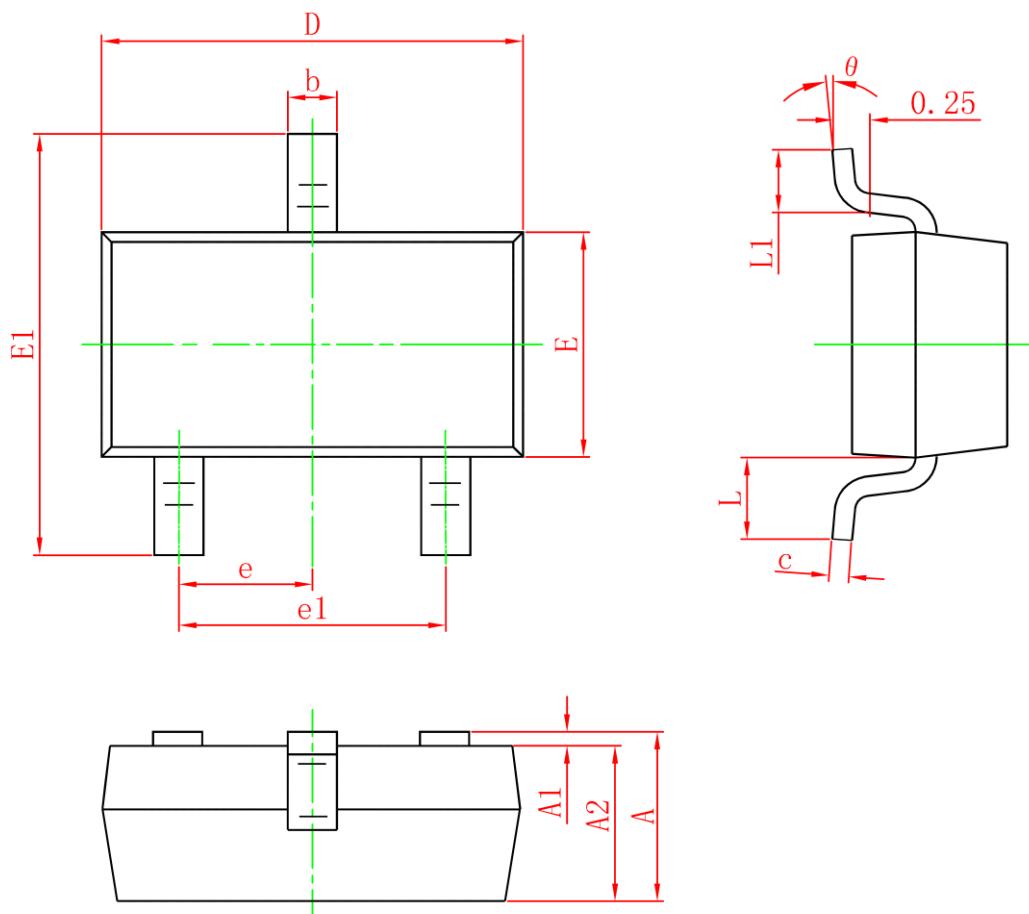
Parameter	Symbol	Test Condition	Min	Type	Max	Unit
<b>Off Characteristics</b>						
Drain - Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0V, I_D = -250\mu\text{A}$	-30			V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{DS} = -30V, V_{GS} = 0V$			-1	$\mu\text{A}$
Gate - Body Leakage Current	$I_{\text{GSS}}$	$V_{GS} = \pm 12V, V_{DS} = 0V$			$\pm 100$	nA
<b>On Characteristics<sup>3</sup></b>						
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = -250\mu\text{A}$	-0.5	-1.0	-1.5	V
Drain-source On-resistance	$R_{DS(\text{on})}$	$V_{GS} = -10V, I_D = -1\text{A}$		99	130	$\text{m}\Omega$
		$V_{GS} = -4.5V, I_D = -1\text{A}$		120	155	
		$V_{GS} = -2.5V, I_D = -1\text{A}$		184	240	
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS} = -15V, V_{GS} = 0V, f = 1\text{MHz}$		383		$\text{pF}$
Output Capacitance	$C_{oss}$			45		
Reverse Transfer Capacitance	$C_{rss}$			31		
Gate Resistance	$R_g$	$V_{DS} = 0V, V_{GS} = 0V, f = 1\text{MHz}$		12		$\Omega$
<b>Switching Characteristics</b>						
Total Gate Charge	$Q_g$	$V_{DS} = -15V, V_{GS} = -10V, I_D = -1\text{A}$		8		$\text{nC}$
Gate-source Charge	$Q_{gs}$			0.7		
Gate-drain Charge	$Q_{gd}$			1.3		
Turn-on Delay Time	$t_{d(\text{on})}$	$V_{DD} = -15V, V_{GS} = -10V, R_L = 7.5\Omega, R_G = 3\Omega$		6		$\text{ns}$
Turn-on Rise Time	$t_r$			4		
Turn-off Delay Time	$t_{d(\text{off})}$			15		
Turn-off Fall Time	$t_f$			6		
<b>Source - Drain Diode Characteristics</b>						
Diode Forward Voltage <sup>3</sup>	$V_{SD}$	$V_{GS} = 0V, I_s = -1.5\text{A}$			-1.2	V

Notes :

- 1.The maximum current rating is limited by package.
- 2.Pulse Test : Pulse Width  $\leq 10\mu\text{s}$ , duty cycle  $\leq 1\%$ .
- 3.Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
- 4.The power dissipation  $P_D$  is limited by  $T_{J(\text{MAX})} = 150^\circ\text{C}$ .
- 5.Device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ\text{C}$ .

## Typical Characteristics



**SOT-23 Package Information**


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0	0.100	0	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.150	1.500	0.045	0.059
E1	2.250	2.650	0.089	0.104
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.550REF		0.022REF	
L1	0.300	0.500	0.012	0.020
theta	0°	8°	0°	8°